ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® MOUSTRIES® MOUSTRIES®	kburn, Illinois, A	ll rights reserved un ntions.	ider both Iev	his docume vel parts, th	ent is a declarati he declaration e	on of the substancompasses al	tances within the manufac ll lower level materials for	turer listed which the	item. Note: if manufacturer	f the item is an as has engineering	ssembly with lower responsibility.	
IPC Web Site for Information o http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg I					on		
Supplier Information												
mpany name* Company unique ID			Unique			que ID Authority			Response Date*			
onsemi									2023-06-06			
Contact Name	Title - Contact			I	Phone - Contact*				Email - Contact*			
Product-Env-Stewards	vards Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
thorized Representative* Title - Representative				Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number Mfr It	em Number	Mfr Item Name			Effective Date	Version	Manufacturing Site	Manufacturing Site		UOM	Unit Type	
SA57	A571DR2G COMPANDOR D		UAL GAIN CON	ITR	2023-06-06	PH1			422.01	mg	Each	
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	1 Terminal Base Alloy		STD-020 MSL R	Rating	Peak Proce	ess Body Tem	perature Max Time at Pe	ak Temper	ature Numb	er of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy 3					260	C	30	seco	onds 3			
Comments												
ATTENTION: MSL 3 Rated item requires Bake and	Dry Pack (after	electrical test)										
for more information regarding material composition	n please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth					
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.84	mg	Supplier	Silicon (Si)	7440-21-3		5.84	mg
Die Attach	16.72	mg		Epoxy resin	proprietary data		0.418	mg
			Supplier	Silver (Ag)	7440-22-4		14.1284	mg
			Supplier	Phenolic Resin	Proprietary Data		0.418	mg
			Supplier	Inorganic filler	Proprietary Data		0.418	mg
			Supplier	Dicyandiamine	461-58-5		0.0836	mg
			Supplier	Formaldehyde Polymer	9003-36-5		1.254	mg
Lead Frame	261.87	mg	Supplier	Silver (Ag)	7440-22-4		2.8806	mg
			Supplier	Zinc (Zn)	7440-66-6		0.5237	mg
			Supplier	Iron (Fe)	7439-89-6		6.8086	mg
			Supplier	Copper (Cu)	7440-50-8		251.6571	mg
Mold Compound-Black	133.38	mg		Epoxy resin	proprietary data		6.669	mg
			Supplier	Phenolic Resin	Proprietary Data		2.6676	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.3345	mg
			Supplier	Carbon Black (C)	1333-86-4		0.6669	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		120.042	mg
Plating	3.83	mg	Supplier	Tin (Sn)	7440-31-5		3.83	mg
Wire Bond - Cu	0.37	mg	Supplier	Copper (Cu)	7440-50-8		0.37	mg